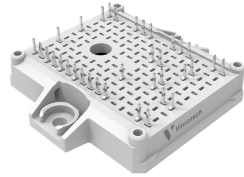
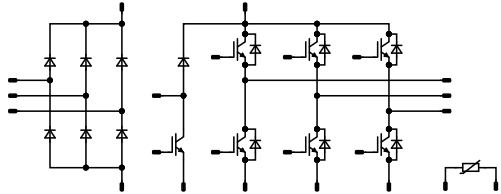




<i>flowPIM E2</i>		1200 V / 35 A	
Features <ul style="list-style-type: none">• IGBT M7 with low VCEsat and improved EMC behavior• Standard industrial housing• Optimized Rth(j-s) with Phase Change Material• Built-in NTC		flow E2 12 mm housing 	
Target applications <ul style="list-style-type: none">• Industrial Drives		Schematic 	
Types <ul style="list-style-type: none">• 10-E212PMA035M7-L188A78Z			



Vincotech

10-E212PMA035M7-L188A78Z
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	108	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	41	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	78	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Brake Switch

Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	51	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	70	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	108	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	9,5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Brake Diode				
Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	19	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	43	W
Maximum junction temperature	T_{jmax}		175	°C

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	58	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	400	A
Surge current capability	I^2t		800	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	68	W
Maximum junction temperature	T_{jmax}		150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition**	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			8.83	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production

** $T_{jmax} > T_j > T_{jop}$ is allowed only for maximum 60 sec overload not exceeding 1/5 duty ratio of each loading cycle for selected semiconductor component under switching conditions.



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	V_F [V]	I_D [A] I_F [A]	T_j [°C]	Min	Typ	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,0035	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		35	25 125 150		1,47 1,64 1,68	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			0,08	mA
Gate-emitter leakage current	I_{GES}		20	0		25			0,5	μA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							7900		pF
Output capacitance	C_{oes}		0	10		25		270		pF
Reverse transfer capacitance	C_{res}							97		pF
Gate charge	Q_g	$V_{CC} = 600$ V	15		35	25		260		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,88		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$					25 125 150		223,4 240,2 233		ns
Rise time	t_r					25 125 150		28 34 35,2		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		227 252,2 259,4		ns
Fall time	t_f					25 125 150		96,87 114,26 122,62		ns
Turn-on energy (per pulse)	E_{on}	$Q_{tFWD} = 3,8$ μC $Q_{tFWD} = 5,84$ μC $Q_{tFWD} = 6,39$ μC				25 125 150		2,45 3,23 3,44		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		2,46 3,24 3,46		mWs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Inverter Diode										
Static										
Forward voltage	V_F				35	25 125 150		1,66 1,76 1,75	2,1 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1200$ V				25			40	μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,22		K/W
Dynamic										
Peak recovery current	I_{RRM}					25 125 150		41,09 40,2 40,64		A
Reverse recovery time	t_{rr}					25 125 150		266,56 425,38 450,01		ns
Recovered charge	Q_r	$di/dt=1364$ A/μs $di/dt=1192$ A/μs $di/dt=1157$ A/μs	±15	600	35	25 125 150		3,8 5,84 6,39		μC
Reverse recovered energy	E_{rec}					25 125 150		1,48 2,39 2,6		mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$					25 125 150		485,16 353,08 342,83		A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GS} [V]	V_{GE} [V]	V_{DS} [V]	I_D [A]	T_j [°C]	Min	Typ	Max	

Brake Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			10	0,0035	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		35	25 125 150		1,47 1,64 1,68	1,85 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			0,08	mA
Gate-emitter leakage current	I_{GES}		20	0		25			0,5	µA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}							7900		pF
Output capacitance	C_{oes}		0	10		25		270		pF
Reverse transfer capacitance	C_{res}							97		pF
Gate charge	Q_g	$V_{CC} = 600$ V	15		35	25		260		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,88		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω	0/15	600	35	25		56		ns
						125		54,08		
						150		53,76		
Rise time	t_r					25		45,12		
						125		46,72		
						150		47,68		
Turn-off delay time	$t_{d(off)}$					25		255,36		
		125		288						
		150		297,92						
Fall time	t_f	25		79,39						
		125		99,71						
		150		106,17						
Turn-on energy (per pulse)	E_{on}	$Q_{tfwd} = 1,79$ µC				25		2,14		mWs
		$Q_{tfwd} = 2,63$ µC				125		2,49		
		$Q_{tfwd} = 2,88$ µC				150		2,61		
Turn-off energy (per pulse)	E_{off}					25		2,65		mWs
						125		3,6		
						150		3,85		



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		
Brake Diode										
Static										
Forward voltage	V_F			10	25 125 150		1,61 1,69 1,7	2,1 ⁽¹⁾		V
Reverse leakage current	I_R	$V_r = 1200$ V			25			25		μA
Thermal										
Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)					2,19			K/W
Dynamic										
Peak recovery current	I_{RRM}				25 125 150		16,27 17,88 18,38			A
Reverse recovery time	t_{rr}				25 125 150		281,59 414 449			ns
Recovered charge	Q_r	$di/dt=564$ A/μs $di/dt=549$ A/μs $di/dt=552$ A/μs	0/15	600	35	25 125 150	1,79 2,63 2,88			μC
Reverse recovered energy	E_{rec}				25 125 150		0,692 1,09 1,21			mWs
Peak rate of fall of recovery current	$(di_r/dt)_{max}$				25 125 150		242,57 180,2 168,69			A/μs



Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Rectifier Diode

Static

Forward voltage	V_F				35	25 125 150		1,09 1,02 1,02	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_T = 1600$ V				25 150			100 2000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,03		K/W
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Thermistor

Static

Rated resistance	R					25		5		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 493$ Ω				100	-5		5	%
Power dissipation	P							245		mW
Power dissipation constant	d					25		1,4		mW/K
B-value	$B_{(25/50)}$	Tol. ±2 %						3375		K
B-value	$B_{(25/100)}$	Tol. ±2 %						3437		K
Vincotech Thermistor Reference									K	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.

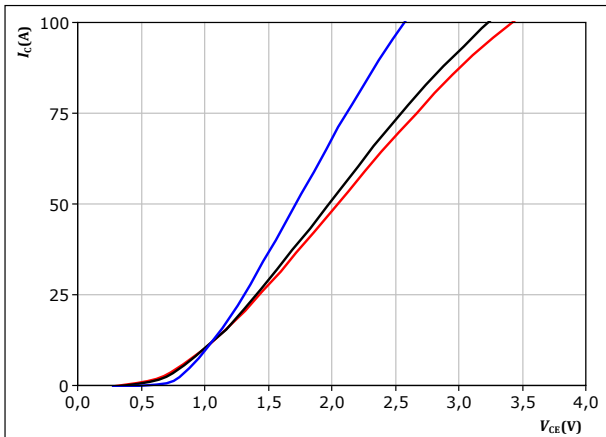


Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



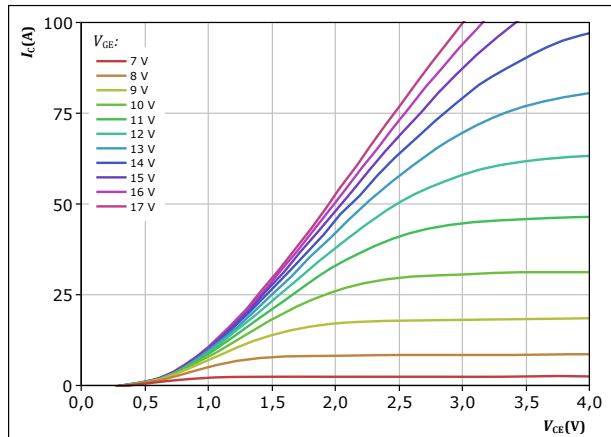
$t_p = 250 \mu s$
 $V_{GE} = 15 V$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

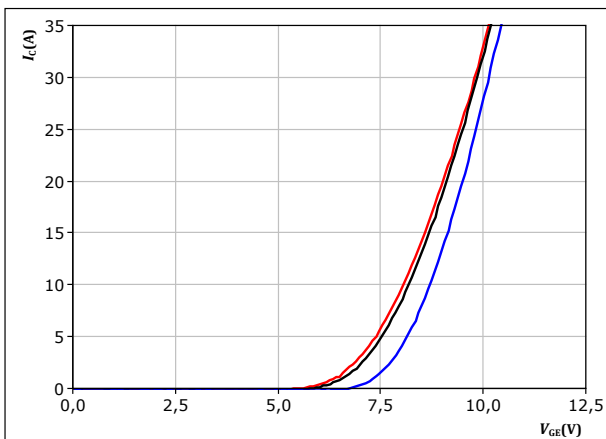


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



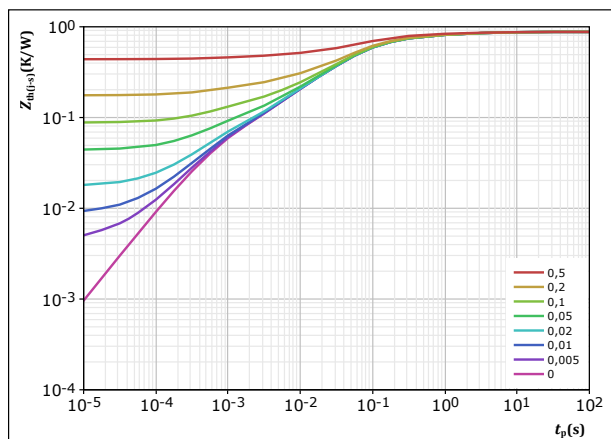
$t_p = 250 \mu s$
 $V_{CE} = 10 V$

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,878 \text{ K/W}$

IGBT thermal model values

R (K/W)	τ (s)
4,21E-02	5,44E+00
8,81E-02	8,75E-01
2,30E-01	1,59E-01
3,79E-01	4,61E-02
9,10E-02	6,73E-03
4,73E-02	6,45E-04



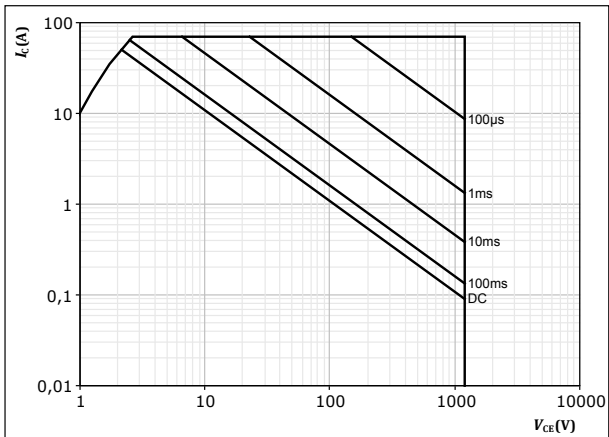
Vincotech

Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



Inverter Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

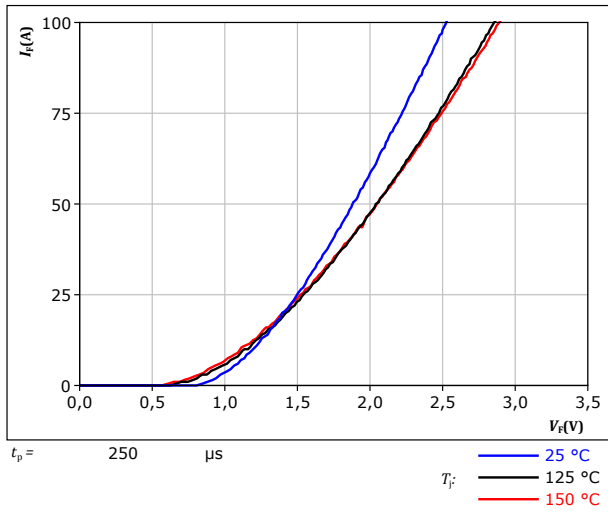
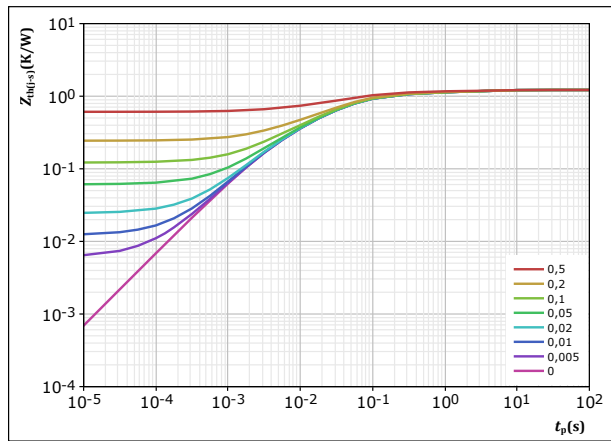


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,219 \text{ K/W}$
 FWD thermal model values

R (K/W)	τ (s)
1,07E-01	3,56E+00
1,60E-01	2,77E-01
5,76E-01	5,00E-02
2,75E-01	1,24E-02
1,01E-01	2,87E-03

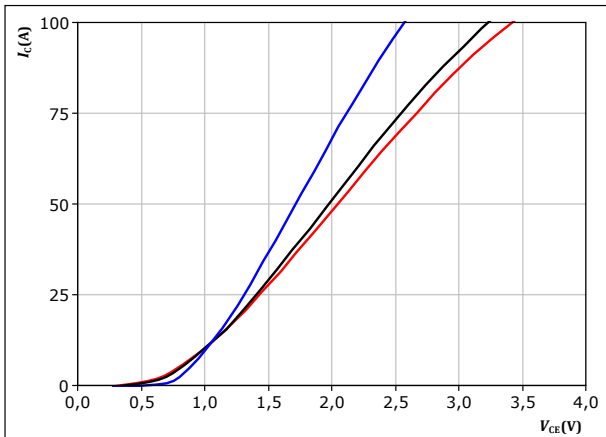


Brake Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

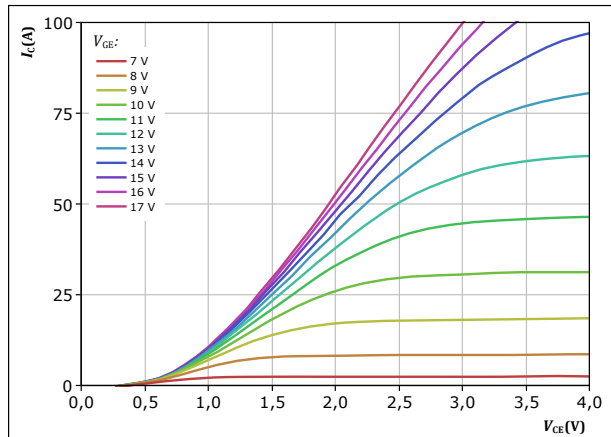


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

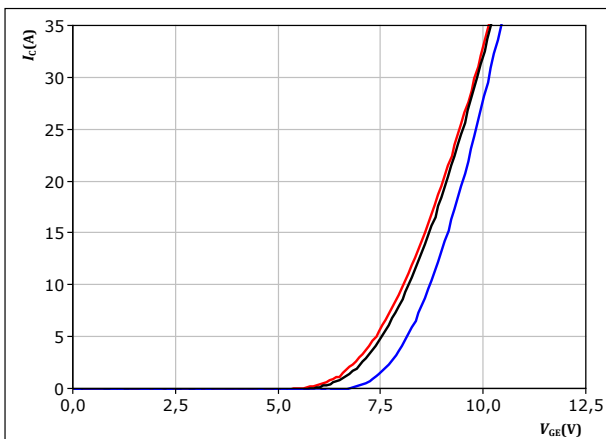


$t_p = 250 \mu s$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

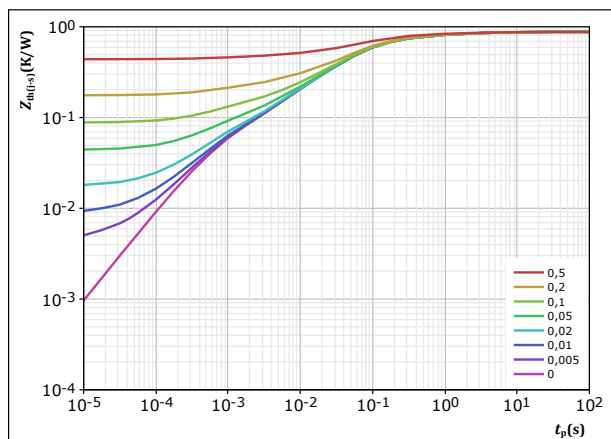


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j:$ 25 °C, 125 °C, 150 °C

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,878 \text{ K/W}$
IGBT thermal model values

R (K/W)	τ (s)
4,21E-02	5,44E+00
8,81E-02	8,75E-01
2,30E-01	1,59E-01
3,79E-01	4,61E-02
9,10E-02	6,73E-03
4,73E-02	6,45E-04



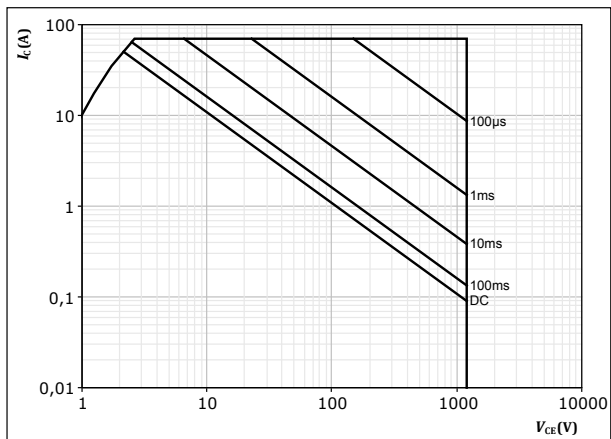
Vincotech

Brake Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$ single pulse

$T_s = 80$ °C

$V_{CE} = 15$ V

$T_j = T_{jmax}$



Brake Diode Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

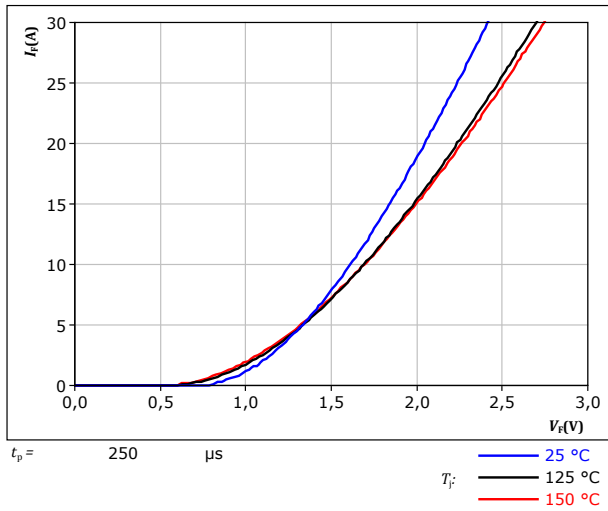
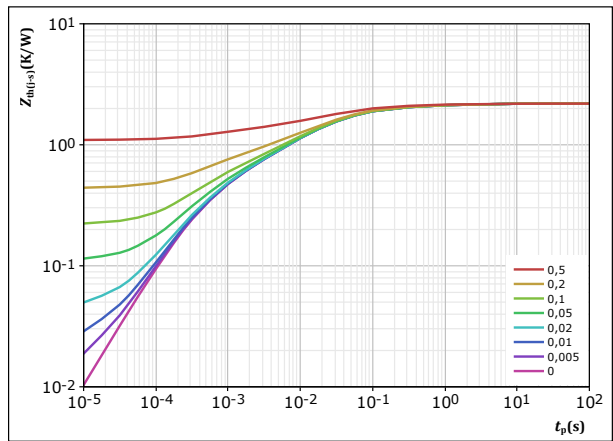


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,189	K/W
FWD thermal model values		
R (K/W)	τ (s)	
8,09E-02	3,20E+00	
2,08E-01	2,82E-01	
6,85E-01	4,41E-02	
5,92E-01	1,02E-02	
3,27E-01	2,02E-03	
2,95E-01	3,64E-04	



Rectifier Diode Characteristics

figure 15. Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$

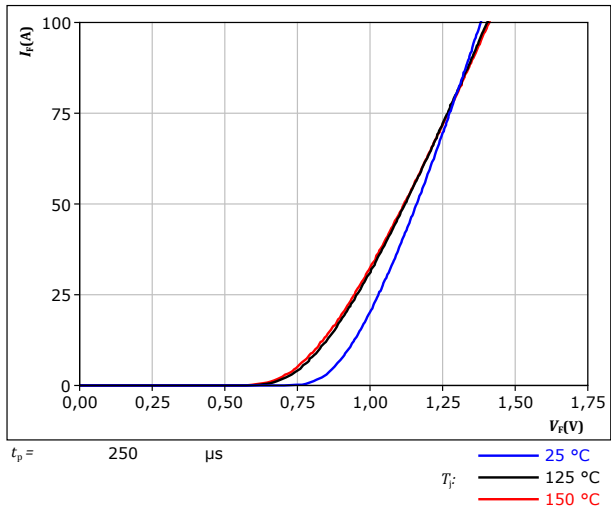
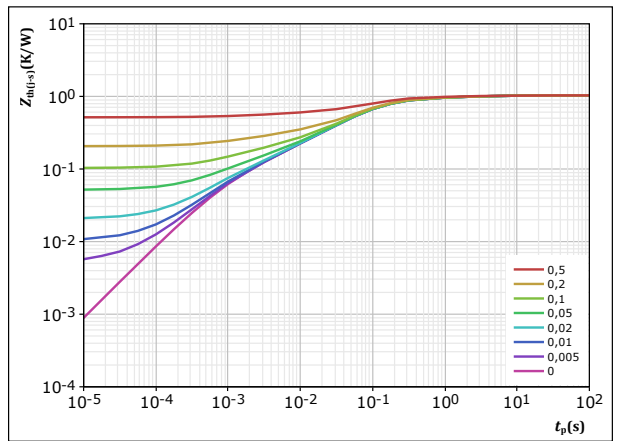


figure 16. Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 1,032 \text{ K/W}$
 Rectifier thermal model values

R (K/W)	τ (s)
4,86E-02	5,67E+00
1,31E-01	6,68E-01
5,24E-01	9,95E-02
1,97E-01	3,35E-02
8,14E-02	4,54E-03
4,98E-02	8,29E-04

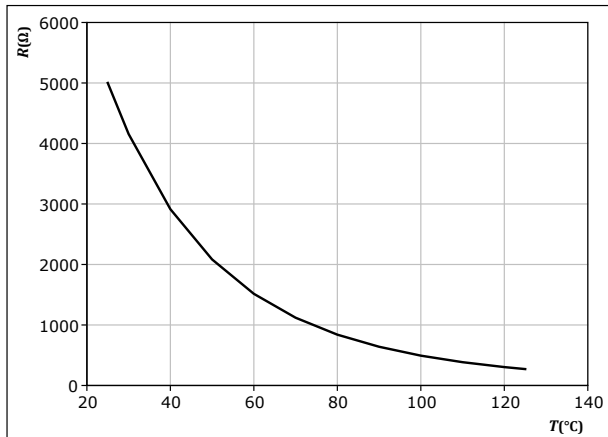


Thermistor Characteristics

figure 17. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

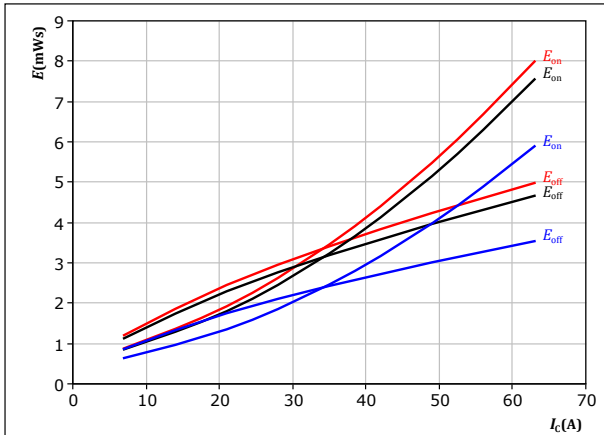




Inverter Switching Characteristics

figure 18. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

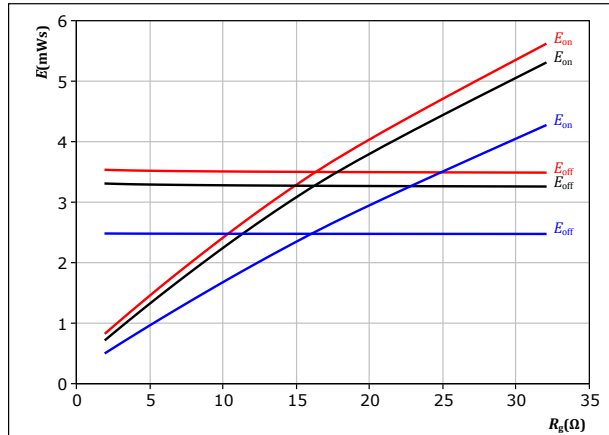


With an inductive load at

$V_{CE} =$	600	V	$T_f:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{gon} =$	16	Ω		—	150 °C
$R_{goff} =$	16	Ω			

figure 19. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

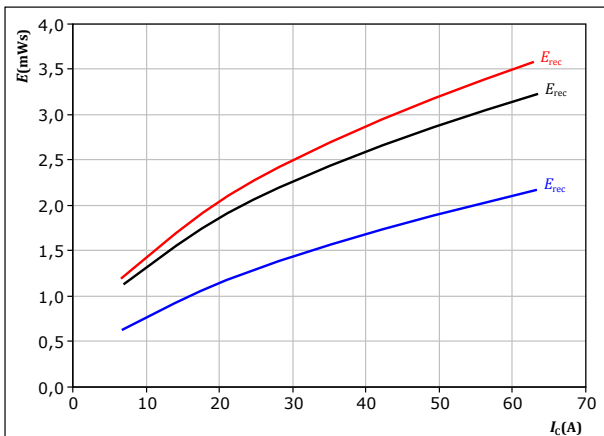


With an inductive load at

$V_{CE} =$	600	V	$T_f:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	35	A		—	150 °C

figure 20. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

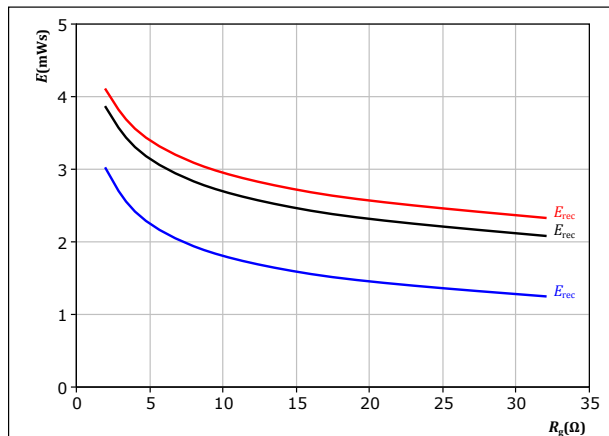


With an inductive load at

$V_{CE} =$	600	V	$T_f:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$R_{gon} =$	16	Ω		—	150 °C

figure 21. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

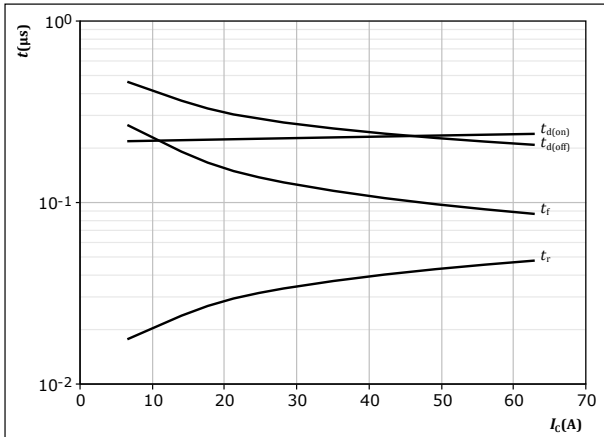
$V_{CE} =$	600	V	$T_f:$	—	25 °C
$V_{GE} =$	±15	V		—	125 °C
$I_c =$	35	A		—	150 °C



Inverter Switching Characteristics

figure 22. IGBT

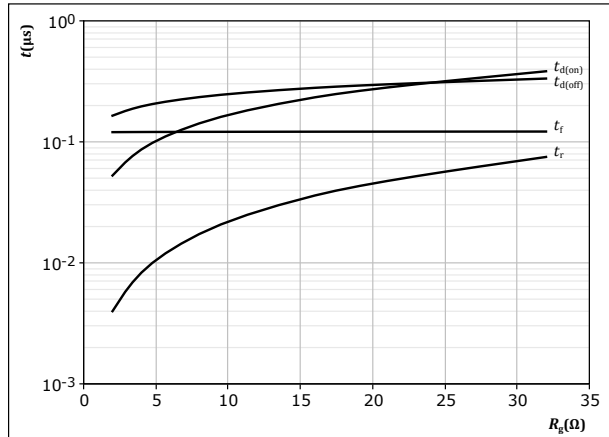
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 16$ Ω
 $R_{g(off)} = 16$ Ω

figure 23. IGBT

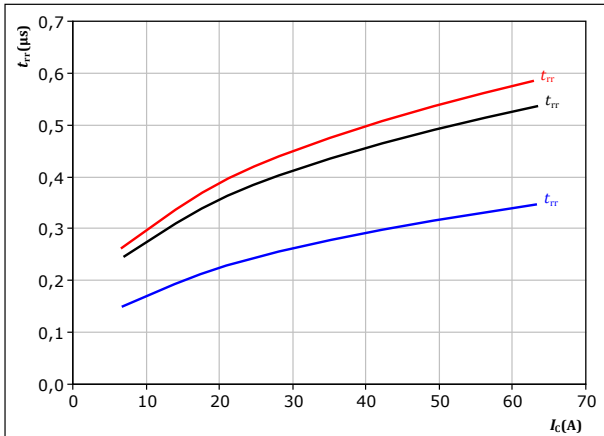
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A

figure 24. FWD

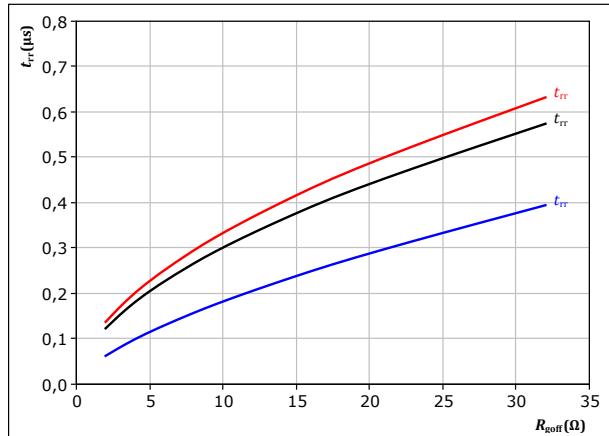
Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{g(on)} = 16$ Ω
 T_j : — 25 °C
— 125 °C
— 150 °C

figure 25. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{g(off)})$



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 T_j : — 25 °C
— 125 °C
— 150 °C

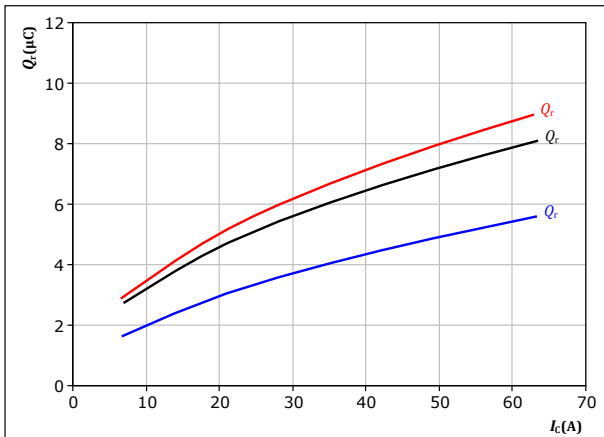


Inverter Switching Characteristics

figure 26. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



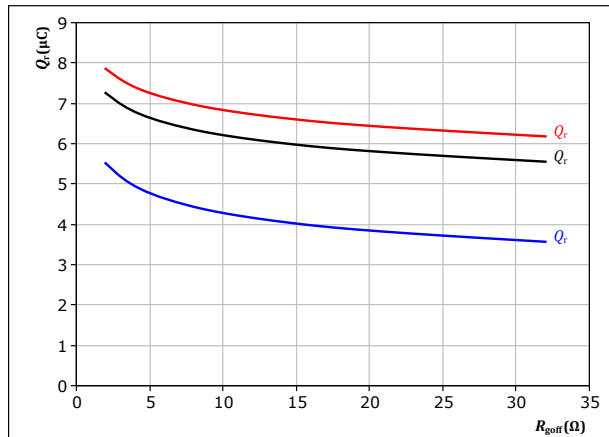
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 16$ Ω
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 27. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



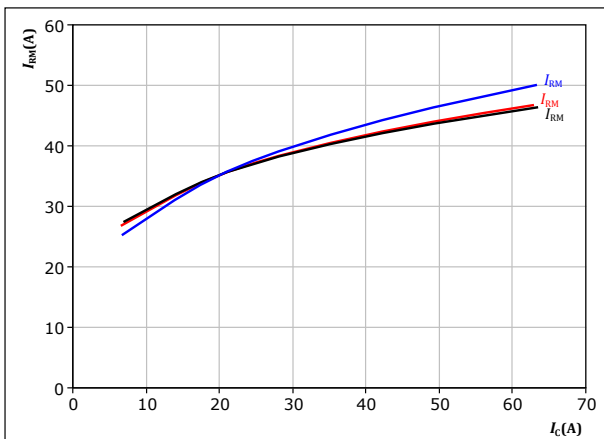
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 28. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



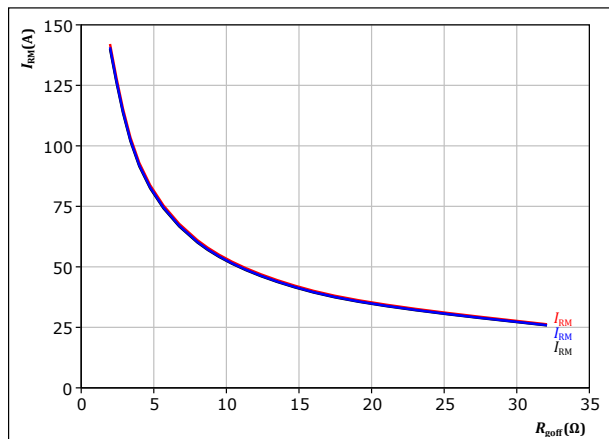
With an inductive load at

$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{goff} = 16$ Ω
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C

figure 29. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

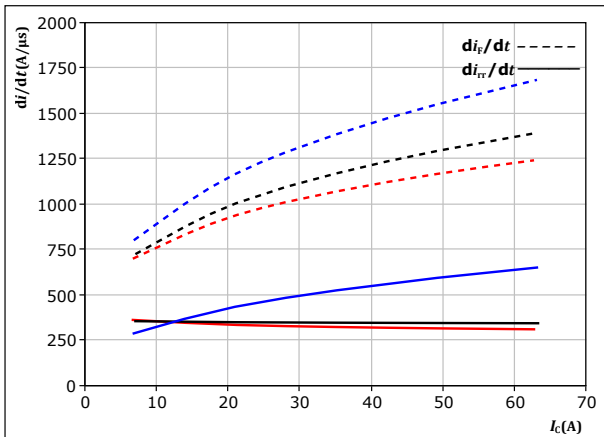
$V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_c = 35$ A
 $T_j:$ — 25 °C
 — 125 °C
 — 150 °C



Inverter Switching Characteristics

figure 30. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_C)$

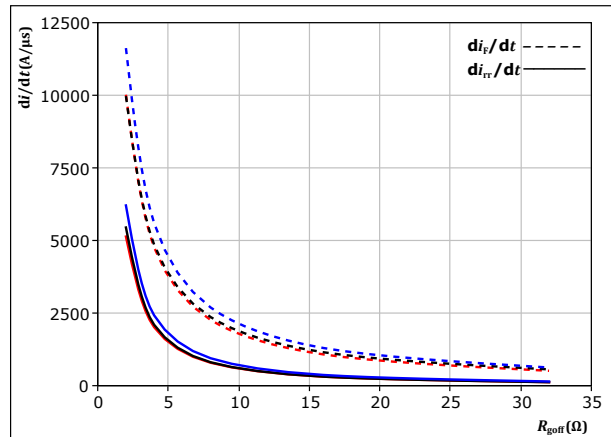


With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{goff} =$	16	Ω		150 °C

figure 31. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



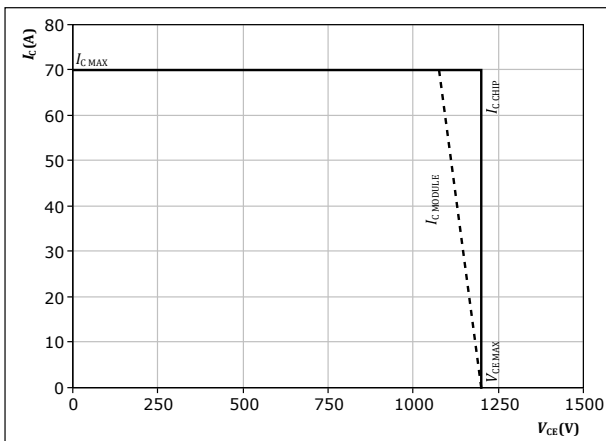
With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_C =$	35	A		150 °C

figure 32. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

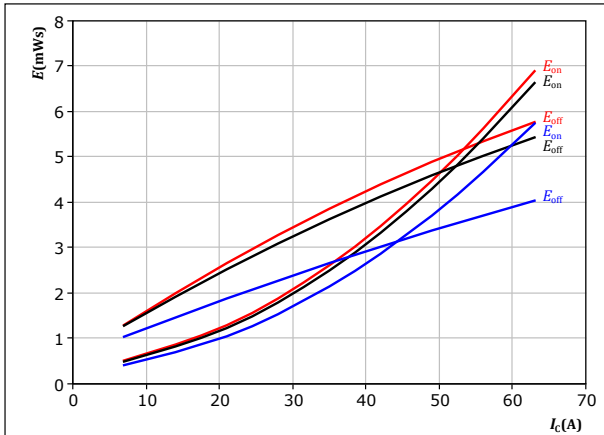
$T_f =$	150	°C
$R_{goff} =$	16	Ω
$R_{goff} =$	16	Ω



Brake Switching Characteristics

figure 33. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_c)$

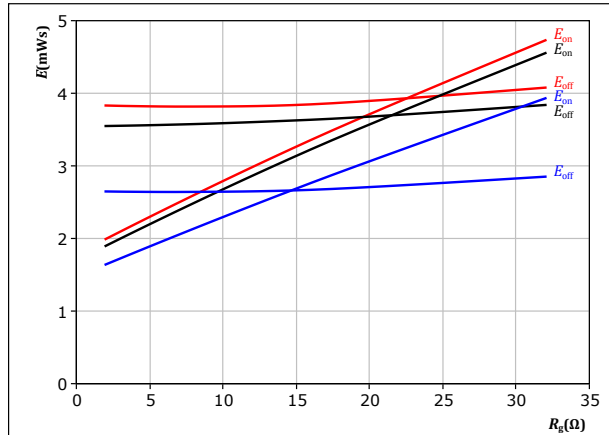


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	0/15	V		125 °C
$R_{gon} =$	8	Ω		150 °C
$R_{goff} =$	8	Ω		

figure 34. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_g)$

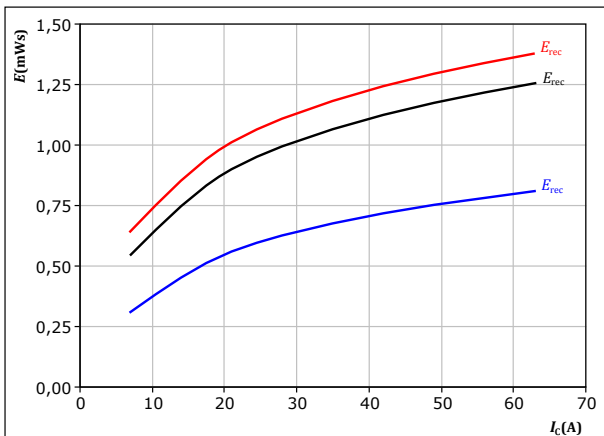


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	0/15	V		125 °C
$I_c =$	35	A		150 °C

figure 35. FWD

Typical reverse recovered energy loss as a function of collector current
 $E_{rec} = f(I_c)$

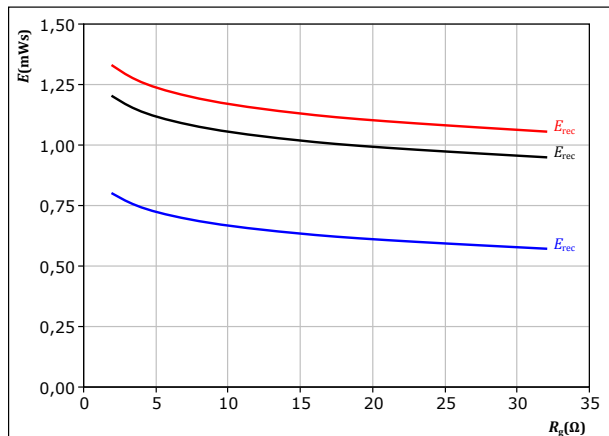


With an inductive load at

$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	0/15	V		125 °C
$R_{gon} =$	8	Ω		150 °C

figure 36. FWD

Typical reverse recovered energy loss as a function of gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at

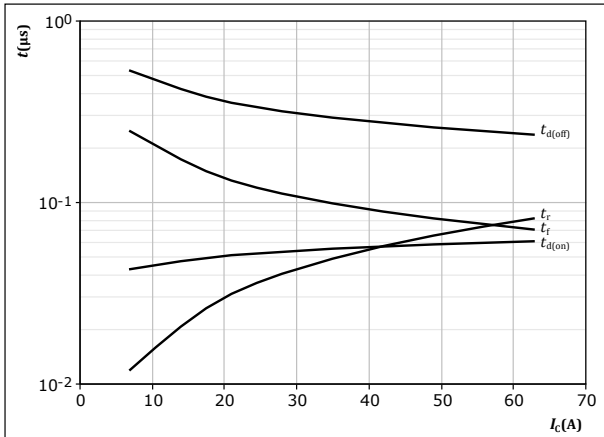
$V_{CE} =$	600	V	$T_j:$	25 °C
$V_{GE} =$	0/15	V		125 °C
$I_c =$	35	A		150 °C



Brake Switching Characteristics

figure 37. IGBT

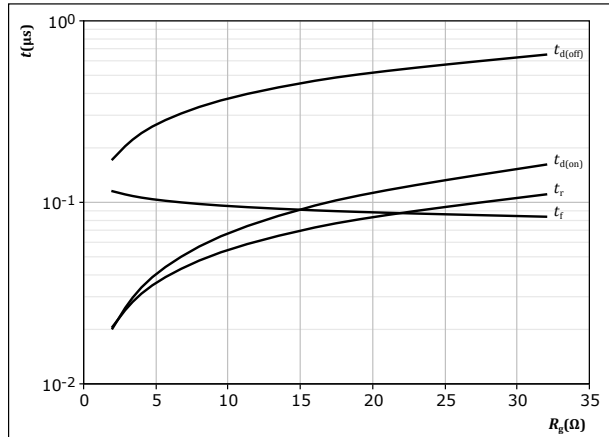
Typical switching times as a function of collector current
 $t = f(I_c)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

figure 38. IGBT

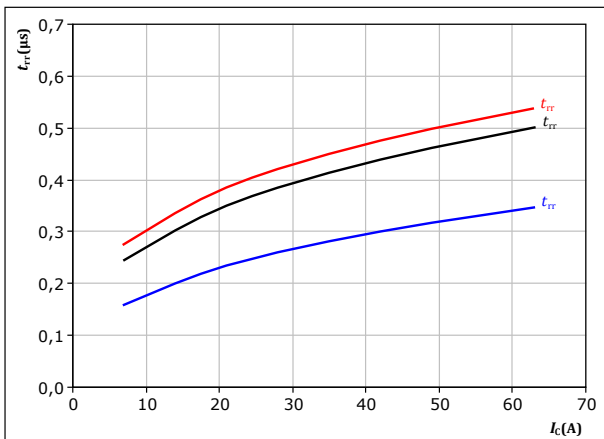
Typical switching times as a function of gate resistor
 $t = f(R_g)$



With an inductive load at
 $T_j = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = 0/15$ V
 $I_c = 35$ A

figure 39. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$

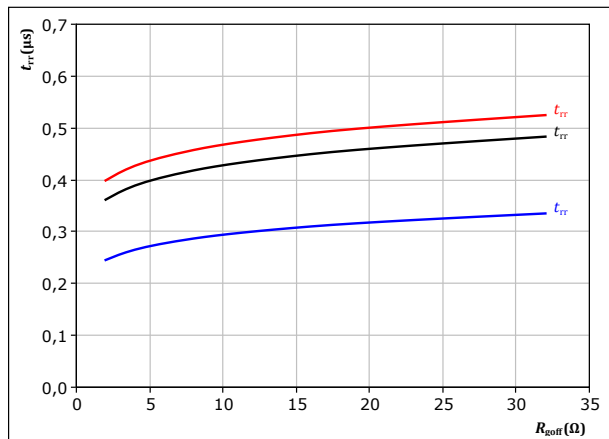


With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 8$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 40. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = 0/15$ V
 $I_c = 35$ A

T_j :
— 25 °C
— 125 °C
— 150 °C

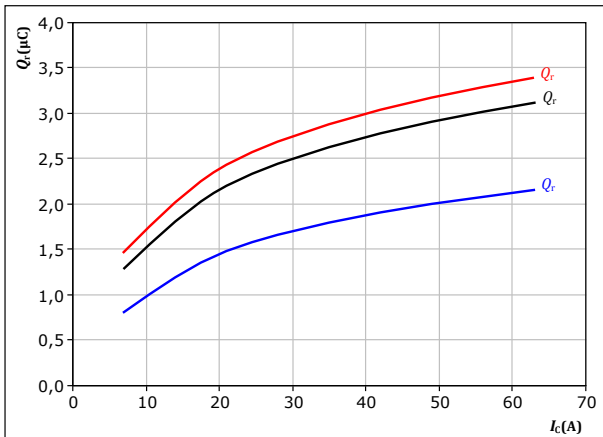


Brake Switching Characteristics

figure 41. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

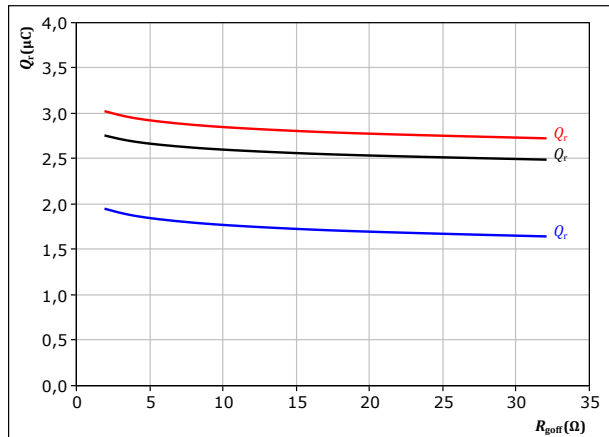
$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 42. FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

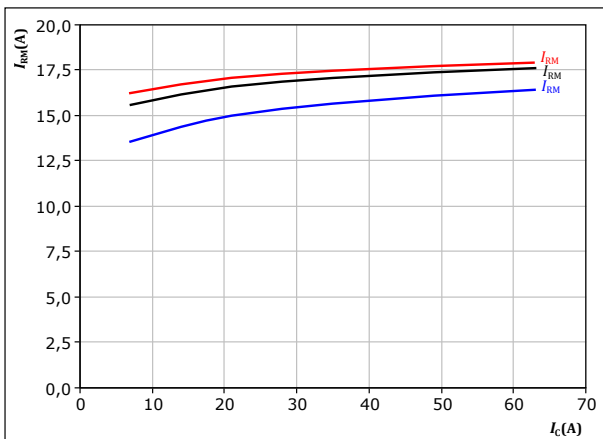
$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 35 \text{ A}$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 43. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

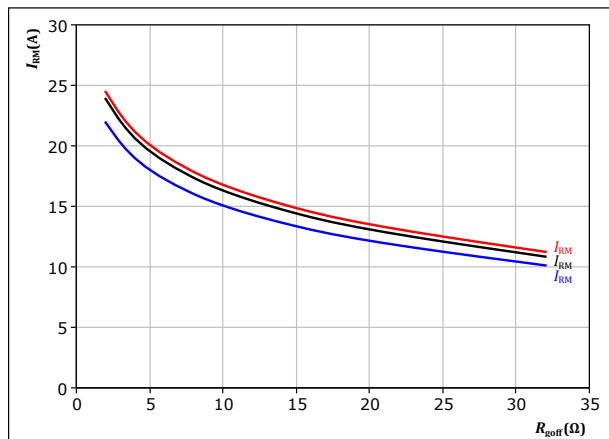
$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)

figure 44. FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 35 \text{ A}$

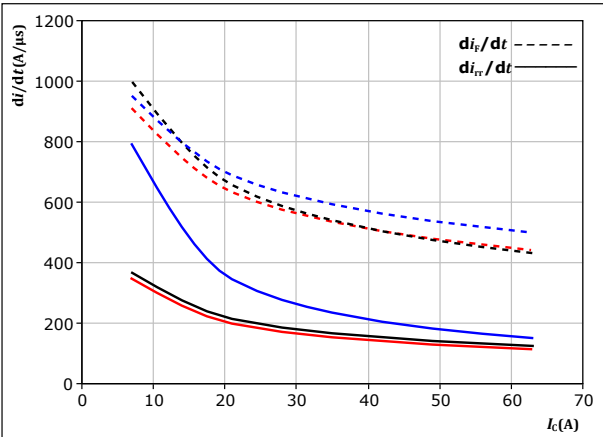
T_j : $25 \text{ } ^\circ\text{C}$ (blue)
 $125 \text{ } ^\circ\text{C}$ (black)
 $150 \text{ } ^\circ\text{C}$ (red)



Brake Switching Characteristics

figure 45. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_c)$



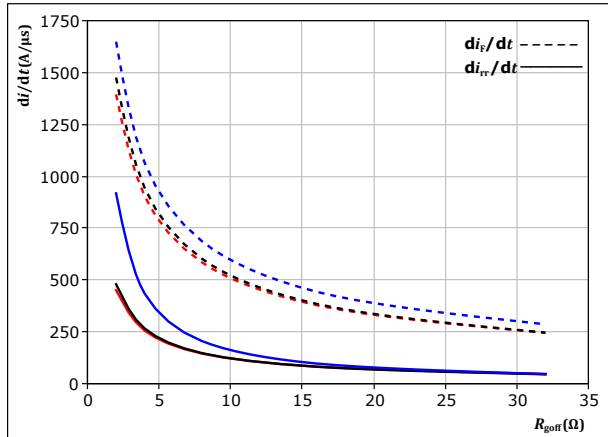
With an inductive load at

$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $R_{goff} = 8 \text{ } \Omega$

$T_j =$
— 25 °C
— 125 °C
— 150 °C

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

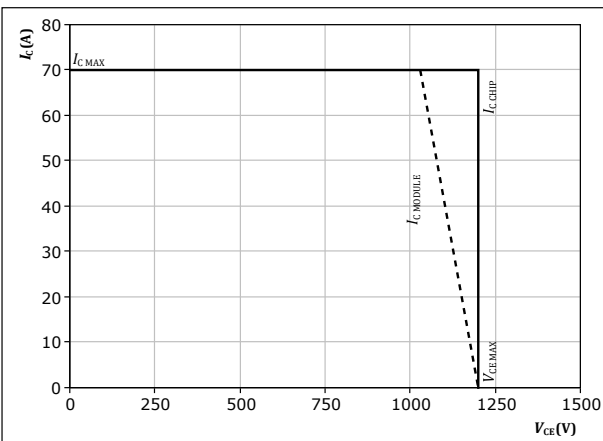
$V_{CE} = 600 \text{ V}$
 $V_{GE} = 0/15 \text{ V}$
 $I_c = 35 \text{ A}$

$T_j =$
— 25 °C
— 125 °C
— 150 °C

figure 47. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{goff} = 8 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$



Switching Definitions

figure 48. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

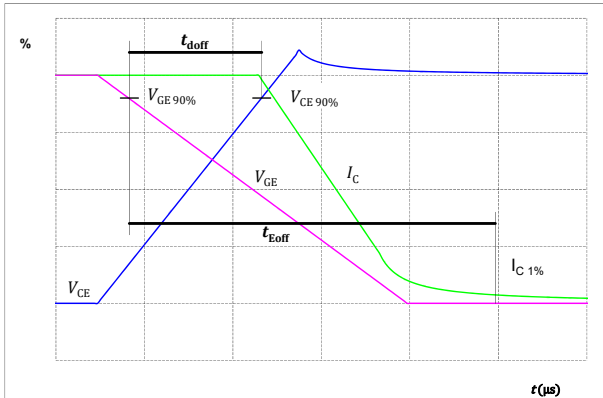


figure 49. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

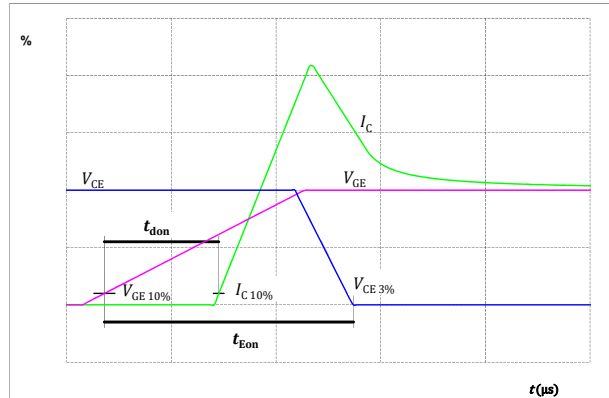


figure 50. IGBT

Turn-off Switching Waveforms & definition of t_f

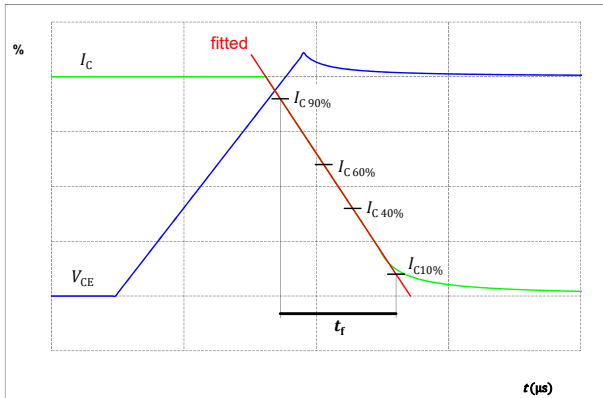
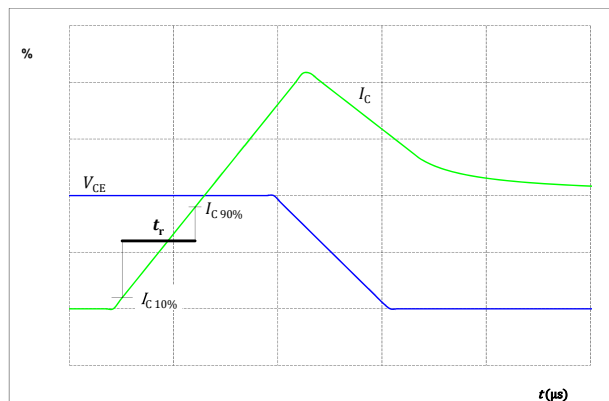


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 52. FWD

Turn-off Switching Waveforms & definition of t_{rr}

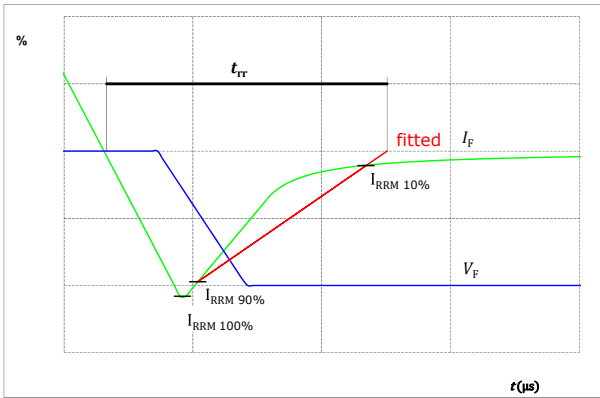
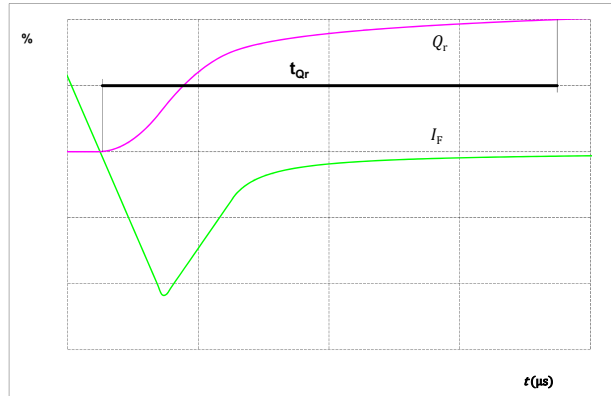


figure 53. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





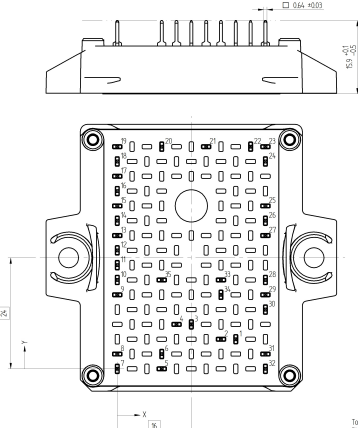
Vincotech

10-E212PMA035M7-L188A78Z
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-E212PMA035M7-L188A78Z
With thermal paste (3,4 W/mK, PSX-P7)	10-E212PMA035M7-L188A78Z-/3/

Marking						
	Text	Name NN-NNNNNNNNNNNNNN- TTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTTTV	Lot number LLLLL	Serial SSSS	Date code WWYY	

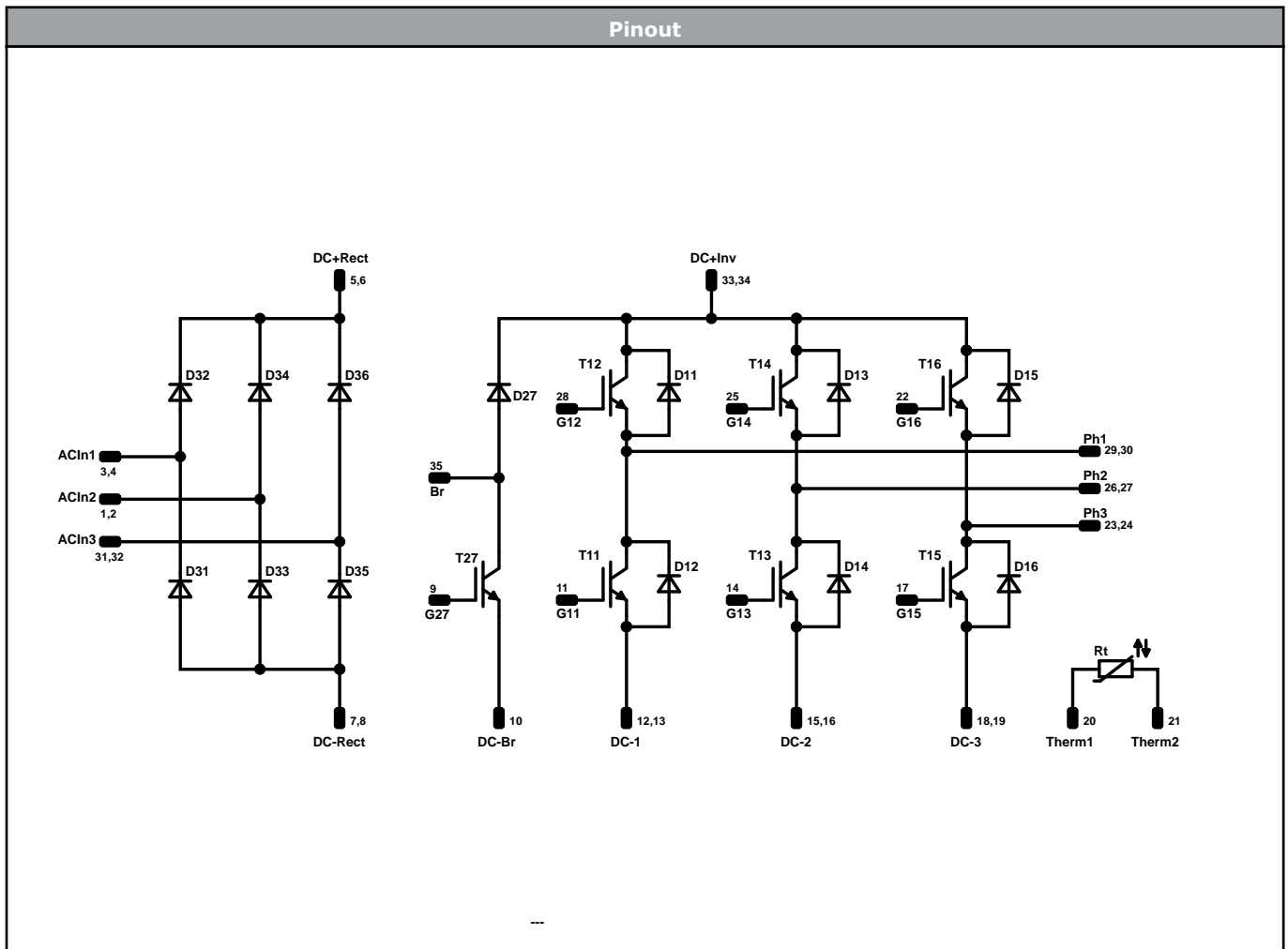
Outline				
Pin table [mm]				
Pin	X	Y	Function	
1	25,6	6,4	ACIn2	
2	22,4	6,4	ACIn2	
3	16	9,6	ACIn1	
4	12,8	9,6	ACIn1	
5	9,6	0	DC+Rect	
6	9,6	3,2	DC+Rect	
7	0	0	DC-Rect	
8	0	3,2	DC-Rect	
9	0	16	G27	
10	0	19,2	DC-Br	
11	0	22,4	G11	
12	0	25,6	DC-1	
13	0	28,8	DC-1	
14	0	32	G13	
15	0	35,2	DC-2	
16	0	38,4	DC-2	
17	0	41,6	G15	
18	0	44,8	DC-3	
19	0	48	DC-3	
20	9,6	48	Therm1	
21	19,2	48	Therm2	
22	28,8	48	G16	
23	32	48	Ph3	
24	32	44,8	Ph3	
25	32	35,2	G14	
26	32	32	Ph2	
27	32	28,8	Ph2	
28	32	19,2	G12	
29	32	16	Ph1	
30	32	12,8	Ph1	
31	32	3,2	ACIn3	
32	32	0	ACIn3	
33	22,4	19,2	DC+Inv	
34	22,4	16	DC+Inv	
35	9,6	19,2	Br	



Tolerance of alignment: ±0,05mm at the end of pins
Deviation of coordinate pins is only offset without tolerance



Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	35 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	35 A	Inverter Diode	
T27	IGBT	1200 V	35 A	Brake Switch	
D27	FWD	1200 V	10 A	Brake Diode	
D31, D32, D33, D34, D35, D36	Rectifier	1600 V	35 A	Rectifier Diode	
Rt	NTC			Thermistor	



Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> E2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E2 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. I @fYVt[b]hcb'j U'X' Zcf HWUgYO%&) \$7 'UbX'Ha Ul O%) \$\$7"



Document No.:	Date:	Modification:	Pages
10-E212PMA035M7-L188A78Z-D4-14	27 Jul. 2021	New datasheet format, separate solder and pressfit pin variant Update characteristics of rectifier diode, leakage current max value from 50 -> 100 uA Update Brake Switching Characteristics No change in the module	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.